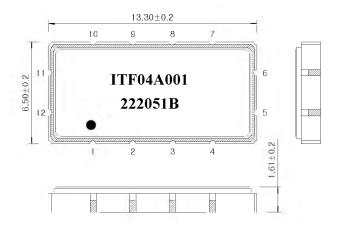
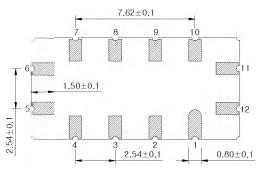


1. Features

- IF Bandpass Filter
- Low-Loss Filter
- Single-Ended Operation
- Ceramic Surface Mount Device (SMD) Package
- Maximum Storage Temperature Range : $-40 \,^{\circ}\text{C} \sim 85 \,^{\circ}\text{C}$
- Electrostatics Sensitive Device (ESD)

2. Package Dimensions





Package: S1365

Dimensions shown are nominal in millimeters

Body : Al₂O₃ Ceramic Lid : Kovar, Ni Plated

Terminations: Au plating $0.3 \sim 1.0$ um, Over a $1.27 \sim 8.89$ um Ni Plating

Pad Configuration					
11	Input				
5	Output				
6, 12	Ground				
Other	Case ground				



3. Specifications

Fo = 62.5 MHz

Terminating source impedance : 50Ω and matching network
Terminating load impedance : 50Ω and matching network

Operating Temperature Range : -10 ℃ ~ +60 ℃		Minimum	Typical	Maximum
Center Frequency	MHz	62.15	62.5	62.85
Insertion Loss	dB	-	14.8	16.5
1dB Bandwidth	MHz	19.7	19.9	-
3dB Bandwidth	MHz	20.3	20.6	-
40dB Bandwidth	MHz	-	23.7	24.2
Amplitude Ripple (Fo +/- 9.3 MHz)	dB	-	0.5	1.0
Group Delay Variation (Fo +/- 9.3 MHz)	nsec	-	50	120
Absolute Delay	usec	-	1.24	-
Temperature Coefficient of Frequency	ppm/°C	-	-86	-

Room Temperature : +25℃		Minimum	Typical	Maximum
Amplitude Ripple (Fo +/- 9.5 MHz)	dB	_	0.6	1.0
Group Delay Variation (Fo +/- 9.5 MHz)	nsec	-	50	120

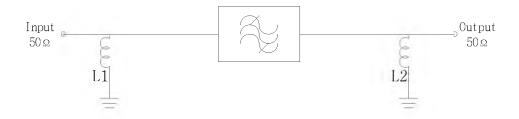
Notes:

- 1) All specifications are based on the matching schematic shown below
- 2) All specifications are measured by Agilent Network analyzer and full 2 port calibration
- Electrical margin has been built into the design to account for the variations due to temperature drift and manufacturing tolerances
- 4) All attenuation measurements are measured relative to insertion loss



4. Matching Schematic

(Actual matching values may vary due to PCB layout and parasitics)



 $L1 = 150 \text{ nH}, \qquad L2 = 82 \text{ nH}$

5. Marking Configuration

ITF¹⁾ 04A001²⁾
222051B³⁾



- 1) Manufacturer name
- 2) Lot Number
- 3) Part Number
- 4) Pad Number 1 Index



6. Typical Performance (at +25℃)

